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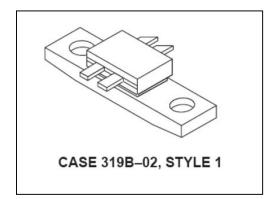
Designed for wideband large signal amplifier and oscillator applications Up to 400 MHz range, in either single-ended or push-pull configuration.

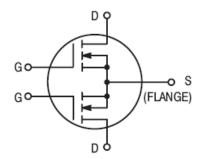
N-Channel enhancement mode

Guaranteed 28 volt, 150 MHz performance
 Output power = 30 Watts
 Broadband gain = 14 dB (Typ.)
 Efficiency = 54% (Typ.)

- Small- and large-signal characterization
- 100% tested for load mismatch at all phase angles with 30:1 VSWR
- Space saving package for push–pull circuit applications
- Excellent thermal stability, ideally suited for Class A operation
- Facilitates manual gain control, ALC and modulation techniques

Product Image





MAXIMUM RATINGS

Rating	Symbol	Value	Unit	
Drain-Source Voltage	V _{DSS}	65	Vdc	
Drain–Gate Voltage (R _{GS} = 1.0 M Ω)	V _{DGR}	65	Vdc	
Gate-Source Voltage	V _{GS}	±40	Vdc	
Drain Current — Continuous	I _D	5.0	Adc	
Total Device Dissipation @ T _C = 25°C Derate above 25°C	P _D	100 0.571	Watts W/°C	
Storage Temperature Range	T _{stg}	-65 to +150	°C	
Operating Junction Temperature	TJ	200	°C	

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	R _{θJC}	1.75	°C/W

Handling and Packaging — MOS devices are susceptible to damage from electrostatic charge. Reasonable precautions in handling and packaging MOS devices should be observed.

PRELIMINARY: Data Sheets contain information regarding a product M/A-COM Technology Solutions has under development. Performance is based on engineering tests. Specifications are typical. Mechanical outline has been fixed. Engineering samples and/or test data may be available. Commitment to produce in volume is not guaranteed.

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MRF136Y



The RF MOSFET Line 30W, to 400MHz, 28V

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ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS (1)	•		•	•	•
Drain-Source Breakdown Voltage (V _{GS} = 0, I _D = 5.0 mA)	V _{(BR)DSS}	65	_	_	Vdc
Zero-Gate Voltage Drain Current (V _{DS} = 28 V, V _{GS} = 0)	I _{DSS}	_	_	2.0	mAdc
Gate–Source Leakage Current (V _{GS} = 40 V, V _{DS} = 0)	I _{GSS}	_	_	1.0	μAdc
ON CHARACTERISTICS (1)	'				
Gate Threshold Voltage (V _{DS} = 10 V, I _D = 25 mA)	V _{GS(th)}	1.0	3.0	6.0	Vdc
Forward Transconductance (V _{DS} = 10 V, I _D = 250 mA)	9 _{fs}	250	400	_	mmhos
DYNAMIC CHARACTERISTICS (1)	-		•	•	•
Input Capacitance (V _{DS} = 28 V, V _{GS} = 0, f = 1.0 MHz)	C _{iss}	_	24	_	pF
Output Capacitance (V _{DS} = 28 V, V _{GS} = 0, f = 1.0 MHz)	C _{oss}	_	27	_	pF
Reverse Transfer Capacitance (V _{DS} = 28 V, V _{GS} = 0, f = 1.0 MHz)	C _{rss}	_	5.5	_	pF
FUNCTIONAL CHARACTERISTICS (2)					
Common Source Power Gain (Figure 1) (V _{DD} = 28 Vdc, P _{out} = 30 W, f = 150 MHz, I _{DQ} = 100 mA)	G _{ps}	12	14	_	dB
Drain Efficiency (Figure 1) (V _{DD} = 28 Vdc, P _{out} = 30 W, f = 150 MHz, I _{DQ} = 100 mA)	η	50	54	_	%
Electrical Ruggedness (Figure 1) (V _{DD} = 28 Vdc, P _{out} = 30 W, f = 150 MHz, I _{DQ} = 100 mA, VSWR 30:1 at all Phase Angles)	Ψ	No Degradation in Output Power			

NOTES:

- 1. Each side measured separately.
- 2. Measured in push-pull configuration.

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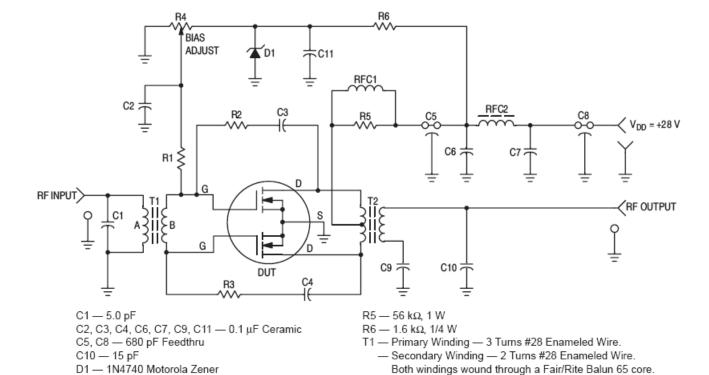


Figure 1. 30-150 MHz Test Circuit

Part #2865002402.

T2 — 1:1 Transformer Wound Bifilar — 2 Turns Twisted Pair

Board Material - 0.062" G10, 1 oz. Cu Clad, Double Sided

#24 Enameled Wire through a Indiana General Balun Q1 core. Part #18006-1-Q1. Primary winding center tapped.

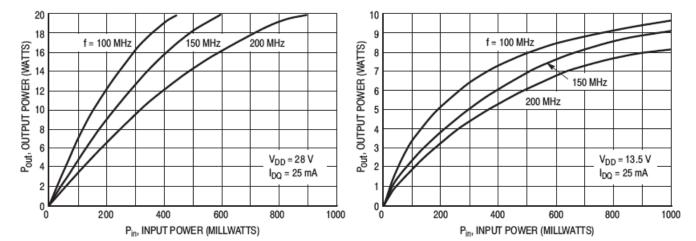


Figure 2. Output Power versus Input Power

RFC1 — 17 Turns, #24 AWG Wound on R5

R1 — 10 kΩ, 1/4 W

R2, R3 — 560 Ω, 1/2 W R4 — 10 Turns, 10 k Ω

RFC2 — Ferroxcube VK-200-19/4B or Equivalent

Figure 3. Output Power versus Input Power

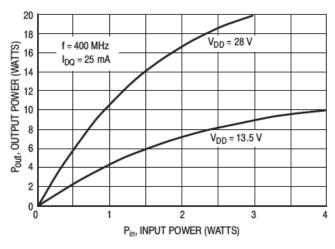
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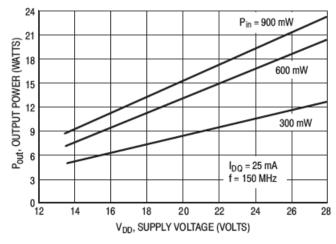
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24 21 Pout, OUTPUT POWER (WATTS) $P_{in} = 600 \text{ mW}$ 18 400 mW 12 200 mW 9 6 I_{DQ} = 25 mA f = 100 MHz 3 12 14 18 20 22 24 26 28 VDD, SUPPLY VOLTAGE (VOLTS)

Figure 4. Output Power versus Input Power

Figure 5. Output Power versus Supply Voltage



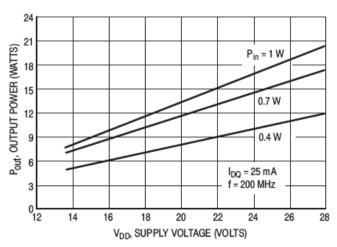


Figure 6. Output Power versus Supply Voltage

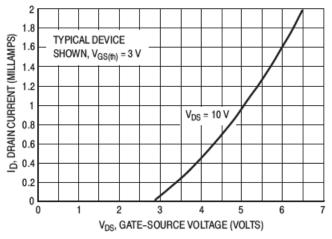
Figure 7. Output Power versus Supply Voltage

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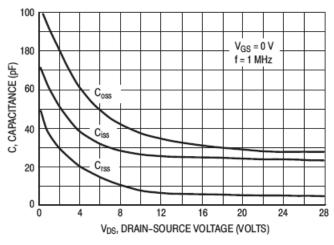
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(NORMALIZED I_D = 750 mA V_{DS} = 28 V 1.03 1.02 500 mA 1.01 GATE-SOURCE VOLTAGE 0.99 0.98 250 mA 0.97 0.96 25 mA ري 30.95 م 0.94 -25 0 50 75 100 125 150 175 T_C, CASE TEMPERATURE (°C)

Figure 8. Drain Current versus Gate Voltage (Transfer Characteristics)*

Figure 9. Gate—Source Voltage versus Case Temperature*



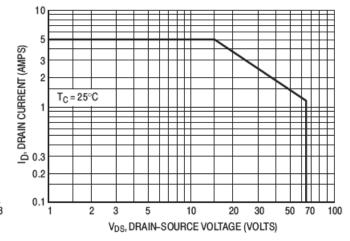


Figure 10. Capacitance versus Drain-Source Voltage

Figure 11. DC Safe Operating Area

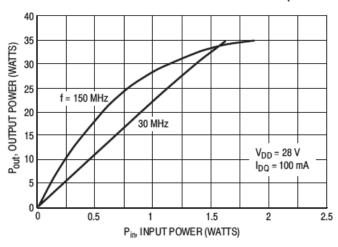
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TYPICAL PERFORMANCE IN BROADBAND TEST CIRCUIT (Refer to Figure 1)



14 12 POWER GAIN (dB) 10 V_{DD} = 28 V 6 $I_{DQ} = 100 \text{ mA}$ Pout = 30 W 20 40 120 140 160 0 f, FREQUENCY (MHz)

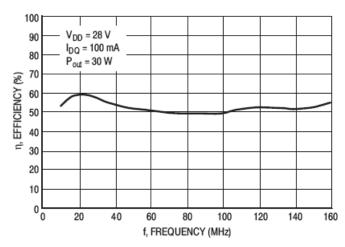
Figure 12. Output Power versus Input Power

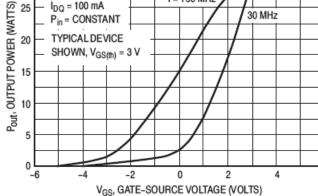
Figure 13. Power Gain versus Frequency

f = 150 MHz

30 MHz

6





 $V_{DD} = 28 \text{ V}$

25

 $I_{DQ} = 100 \text{ mA}$

Pin = CONSTANT

Figure 14. Drain Efficiency versus Frequency

Figure 15. Output Power versus Gate Voltage

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TYPICAL 400 MHz PERFORMANCE

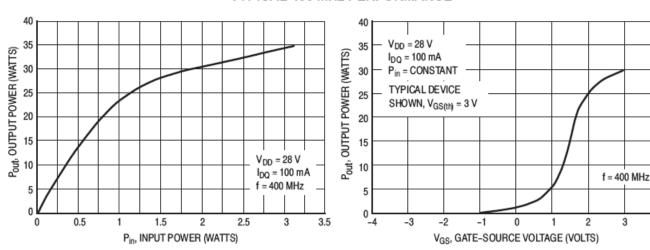


Figure 16. Output Power versus Input Power

Figure 17. Output Power versus Gate Voltage

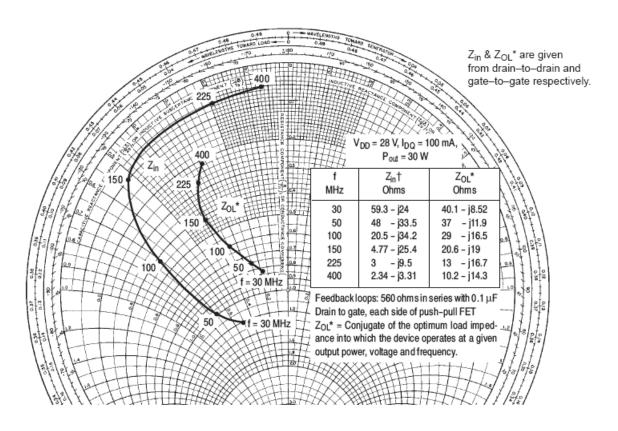


Figure 18. Input and Output Impedance

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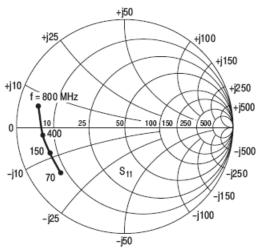


Figure 19. S₁₁, Input Reflection Coefficient versus Frequency V_{DS} = 28 V I_D = 0.5 A

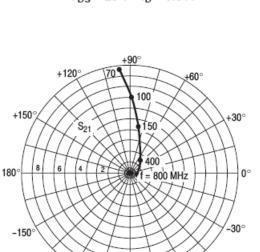


Figure 21. S_{21} , Forward Transmission Coefficient versus Frequency $V_{DS} = 28 \text{ V}$ $I_D = 0.5 \text{ A}$

-120

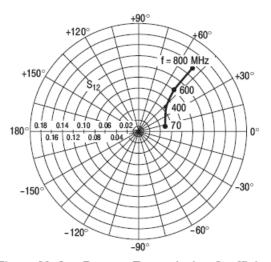


Figure 20. S_{12} , Reverse Transmission Coefficient versus Frequency $V_{DS} = 28 \text{ V}$ $I_D = 0.5 \text{ A}$

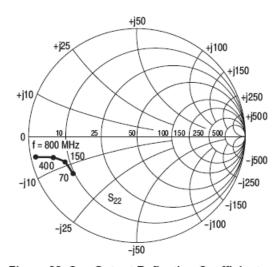


Figure 22. S_{22} , Output Reflection Coefficient versus Frequency $V_{DS} = 28 \text{ V}$ $I_D = 0.5 \text{ A}$

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MRF136Y



The RF MOSFET Line 30W, to 400MHz, 28V

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RF POWER MOSFET CONSIDERATIONS

DESIGN CONSIDERATIONS

The MRF137 is a RF power N-Channel enhancement-mode field-effect transistor (FET) designed especially for VHF power amplifier applications. M/A-COM RF MOS FETs feature a vertical structure with a planar design, thus avoiding the processing difficulties associated with V-groove vertical power FETs.

M/A-COM Application Note AN211A, FETs in Theory and-Practice, is suggested reading for those not familiar with the construction and characteristics of FETs.

The major advantages of RF power FETs include high gain, low noise, simple bias systems, relative immunity from thermal runaway, and the ability to withstand severely mismatched loads without suffering damage. Power output can be varied over a wide range with a low power dc control signal, thus facilitating manual gain control, ALC and modulation.

DC BIAS

The MRF137 is an enhancement mode FET and, therefore, does not conduct when drain voltage is applied. Drain current flows when a positive voltage is applied to the gate. See Figure 10 for a typical plot of drain current versus gate voltage. RF power FETs require forward bias for optimum performance.

The value of quiescent drain current (IDQ) is not critical formany applications. The MRF137 was characterized at IDQ = 25 mA, which is the suggested minimum value of IDQ. For special applications such as linear amplification, IDQ may have to be selected to optimize the critical parameters.

The gate is a dc open circuit and draws no current. Therefore, the gate bias circuit may generally be just a simple

resistive divider network. Some special applications may require a more elaborate bias system.

GAIN CONTROL

Power output of the MRF137 may be controlled from its rated value down to zero (negative gain) by varying the dc gate voltage. This feature facilitates the design of manual gain control, AGC/ALC and modulation systems. (See Figure 9.)

AMPLIFIER DESIGN

Impedance matching networks similar to those used with bipolar VHF transistors are suitable for MRF137. See M/A-COM Application Note AN721, Impedance Matching Networks Applied to RF Power Transistors. The higher input impedance of RF MOS FETs helps ease the task of broadband network design. Both small signal scattering parameters and large signal impedances are provided. While the s-parameters will not produce an exact design solution for high power operation, they do yield a good first approximation. This is an additional advantage of RF MOS power FETs.

RF power FETs are triode devices and, therefore, not unilateral. This, coupled with the very high gain of the MRF137, yields a device capable of self oscillation. Stability may be achieved by techniques such as drain loading, input shunt resistive loading, or output to input feedback. Two port parameter stability analysis with the MRF137 sparameters provides a useful tool for selection of loading or feedback circuitry to assure stable operation. See M/A-COM Application Note AN215A for a discussion of two port network theory and stability.

LOW NOISE OPERATION

Input resistive loading will degrade noise performance, and noise figure may vary significantly with gate driving impedance. A low loss input matching network with its gate impedance optimized for lowest noise is recommended.

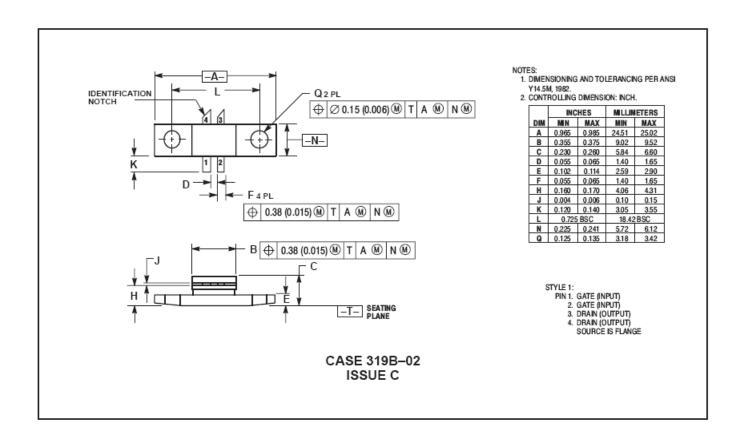
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